

BCR2AS-14A

Triac
Low Power Use

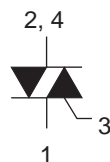
R07DS0257EJ0100
Rev.1.00
Feb 28, 2011

Features

- $I_{T(RMS)}$: 2 A
- V_{DRM} : 700 V
- I_{FGT} , I_{RGT} , I_{RGT} : 10 mA
- Non-Insulated Type
- Planar Passivation Type

Outline

RENESAS Package code: PRSS0004ZG-A
(Package name : MP-3A)



1. T₁ Terminal
2. T₂ Terminal
3. Gate Terminal
4. T₂ Terminal

Applications

Small motor control, heater control, and other general purpose AC power control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		14	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	700	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	840	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	2	A	Commercial frequency, sine full wave 360°conduction
Surge on-state current	I_{TSM}	9	A	50Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	0.41	A ² s	Value corresponding to 1 cycle of half wave 50Hz, surge on-state current
Peak gate power dissipation	P_{GM}	1	W	
Average gate power dissipation	$P_{G(AV)}$	0.1	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	1	A	
Junction temperature	T_j	- 40 to +125	°C	
Storage temperature	T_{stg}	- 40 to +125	°C	
Mass	—	0.26	g	Typical value

Notes: 1. Gate open.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	1.0	mA	$T_j = 125^\circ\text{C}$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	2.1	V	$T_c = 25^\circ\text{C}$, $I_{TM} = 3\text{A}$, instantaneous measurement
Gate trigger voltage ^{Note2}	I	V_{FGTI}	—	—	2.0	$T_j = 25^\circ\text{C}$, $V_D = 6\text{V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	V_{RGTI}	—	—	2.0	
	III	V_{RGTIII}	—	—	2.0	
Gate trigger current ^{Note2}	I	I_{FGTI}	—	—	10	$T_j = 25^\circ\text{C}$, $V_D = 6\text{V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	I_{RGTI}	—	—	10	
	III	I_{RGTIII}	—	—	10	
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 125^\circ\text{C}$, $V_D = 1/2 V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	4.0	$^\circ\text{C/W}$	Junction to case ^{Note3}
Critical-rate of rise of off-state commutation voltage ^{Note4}	$(dv/dt)_c$	0.5	—	—	$\text{V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

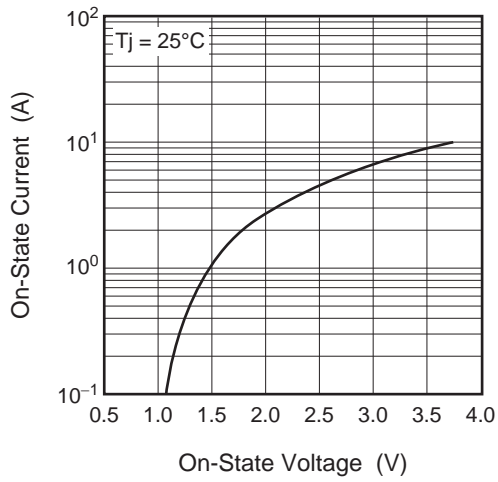
3. Case temperature is measured on the T_2 tab.

4. Test conditions of the critical-rate of rise of off-state commutation voltage is shown in the table below.

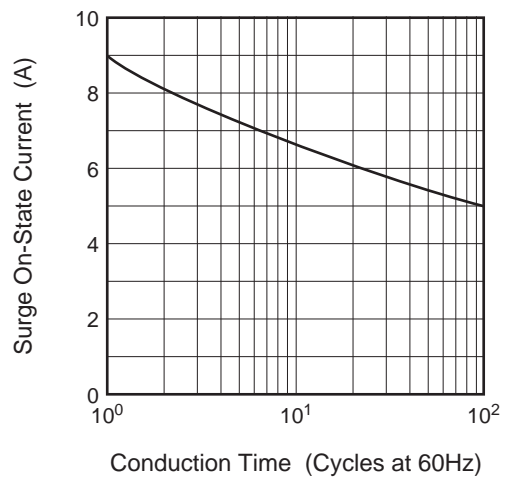
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = -1.0\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Performance Curves

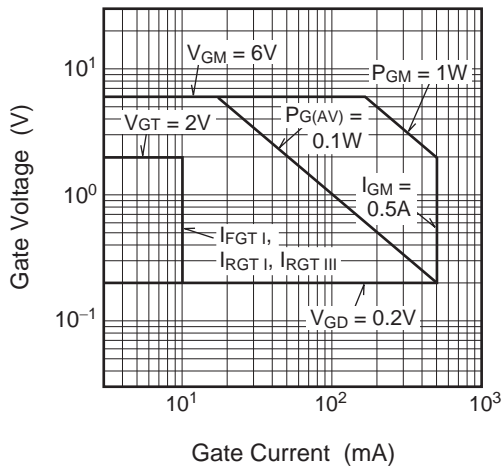
Maximum On-State Characteristics



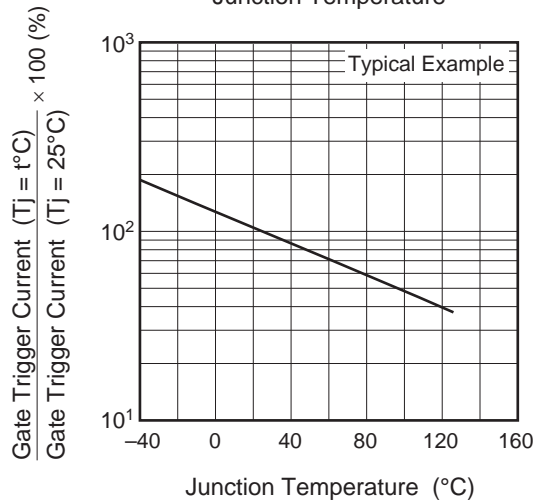
Rated Surge On-State Current



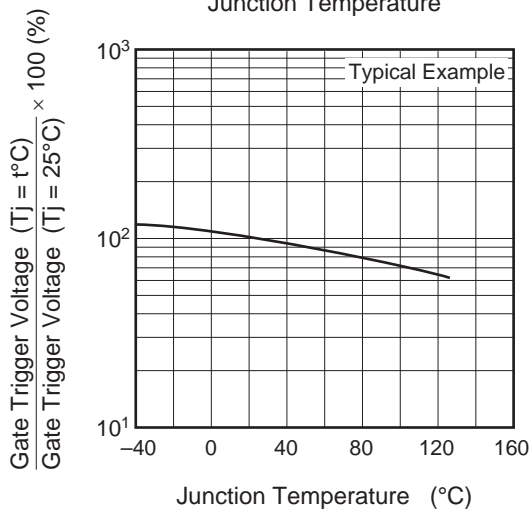
Gate Characteristics



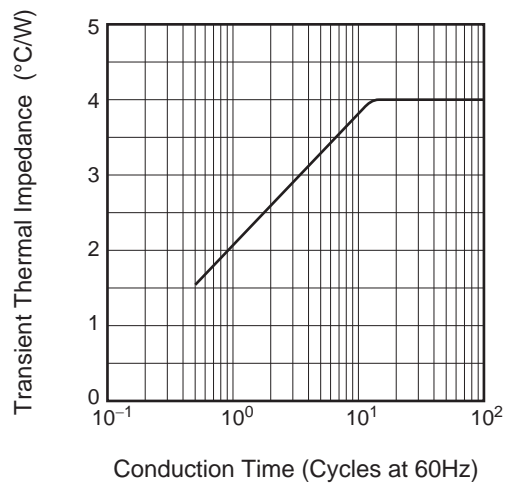
Gate Trigger Current vs. Junction Temperature



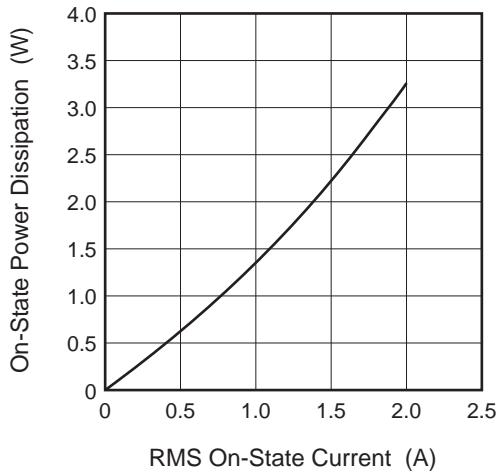
Gate Trigger Voltage vs. Junction Temperature



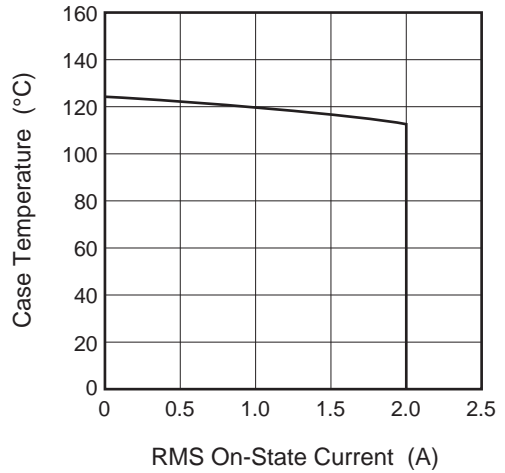
Maximum Transient Thermal Impedance Characteristics (Junction to case)



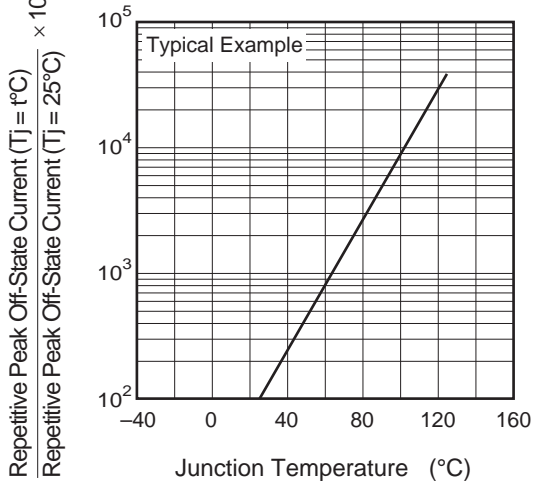
Maximum On-State Power Dissipation



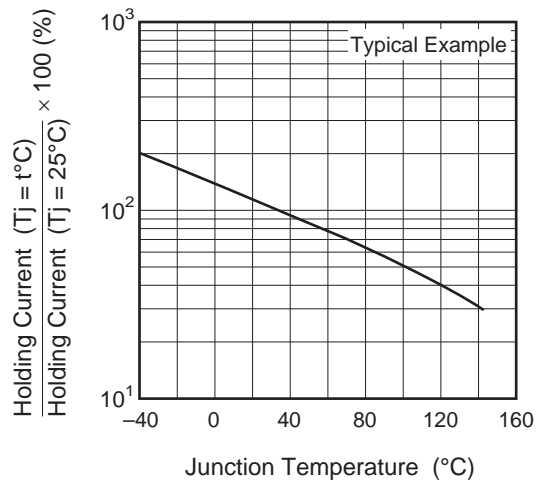
Allowable Case Temperature vs. RMS On-State Current



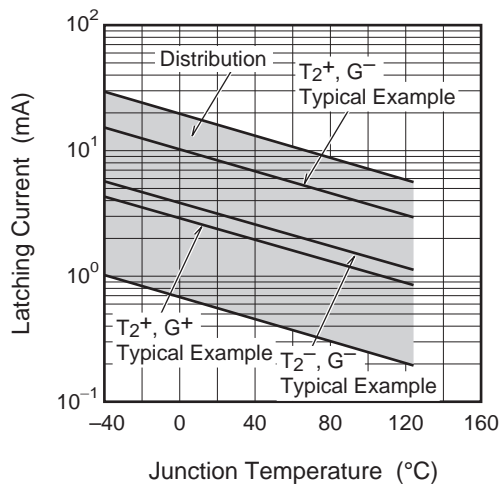
Repetitive Peak Off-State Current vs. Junction Temperature



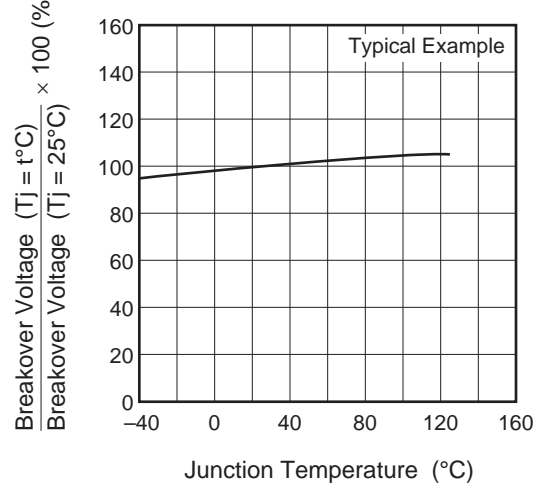
Holding Current vs. Junction Temperature



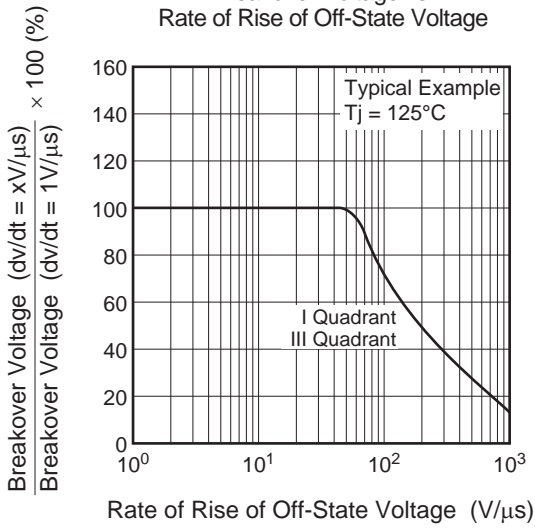
Latching Current vs. Junction Temperature



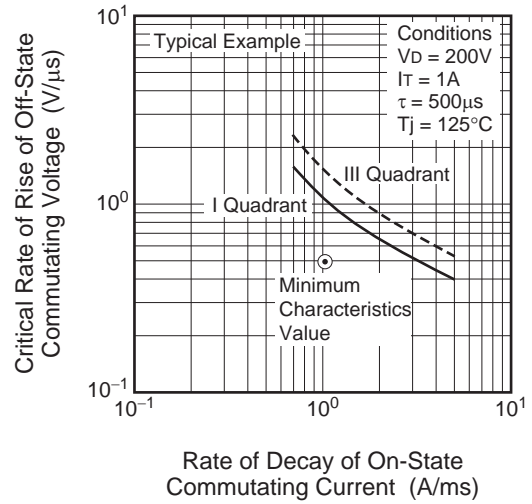
Breakover Voltage vs. Junction Temperature



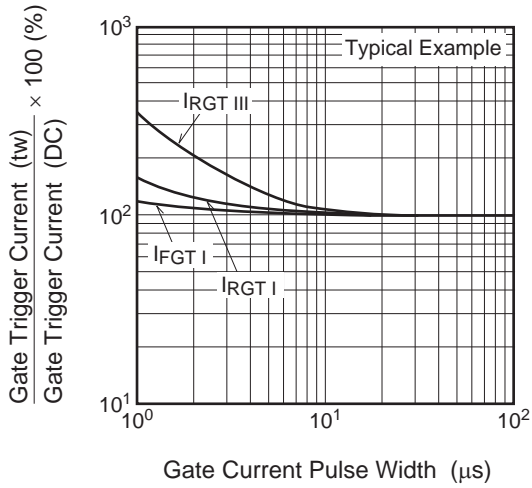
Breakover Voltage vs. Rate of Rise of Off-State Voltage



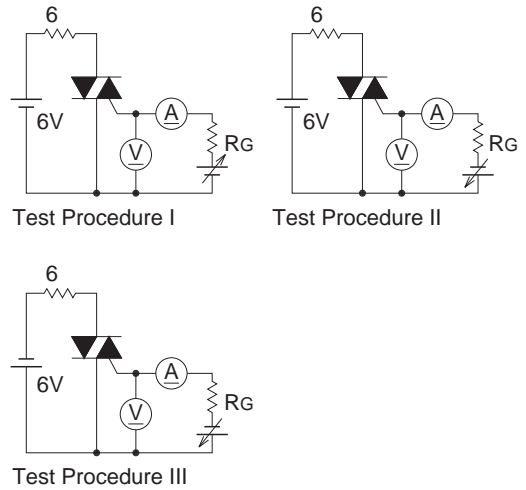
Commutation Characteristics (Tj=125°C)



Gate Trigger Current vs. Gate Current Pulse Width



Gate Trigger Characteristics Test Circuits



Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
MP-3A	SC-63	PRSS0004ZG-A	TMP3	0.32g	

The drawing shows three views of the package:

- Top View:** Shows a rectangular package with a width of 6.6 mm and a length of 10.4 mm (maximum). The central body has a width of 5.3 ± 0.2 mm and a height of 1 ± 0.2 mm. The distance between the two leads is 2.3 ± 0.2 mm. The lead width is 0.76 ± 0.2 mm, and the lead thickness is 1 Max.
- Side View:** Shows the package height of 6.1 ± 0.2 mm. The lead height is 2.5 Min. The lead thickness is 0.5 ± 0.2 mm. The distance from the lead tip to the package body is 1.4 ± 0.2 mm. The package body has a thickness of 0.1 ± 0.1 mm.
- Bottom View:** Shows the package thickness of 2.3 mm and the lead thickness of 1 mm.

Ordering Information

Orderable Part Number	Packing	Quantity	Remark
BCR2AS-14A#B00	Tube	75 pcs.	—
BCR2AS-14A-T13#B00	Embossed Tape	3000 pcs.	Taping direction "T1"

Note : Please confirm the specification about the shipping in detail.

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